

Product data sheet

1. General description

Ultrafast power diode in a SOD113 (2-lead TO-220F) plastic package.

2. Features and benefits

- Fast switching
- Isolated plastic package
- Low leakage current
- Low forward voltage drop
- Low thermal resistance
- Soft recovery characteristic
- Enhanced avalanche energy capability

3. Applications

- · High frequency switched-mode power supplies
- Discontinuous Current Mode (DCM) Power Factor Correction (PFC)

4. Quick reference data

Symbol	Parameter	Conditions		Values			Unit
Absolute	e maximum rating						
V _{RRM}	repetitive peak reverse voltage			e	600		V
I _{F(AV)}	average forward current	δ = 0.5 ; square-wave pulse; T _h ≤ 71 °C; Fig. 1; Fig. 2; Fig. 3			10		A
I _{FRM}	repetitive peak forward current	δ = 0.5 ; t _p = 25 µs; T _h ≤ 71 °C; square-wave pulse		20			А
I _{FSM}	non-repetitive peak forward current	t_p = 10 ms; $T_{j(init)}$ = 25 °C; sine-wave pulse; Fig. 4	75			A	
		t_{p} = 8.3 ms; $T_{\text{j(init)}}$ = 25 °C; sine-wave pulse;	83			А	
Symbol	Parameter	Conditions		Min	Тур	Max	Unit
Static ch	aracteristics		I				
V _F	forward voltage	I _F = 10 A; T _j = 25 °C; <u>Fig. 6</u>		-	1.55	2	V
		I _F = 10 A; T _j = 150 °C; <u>Fig. 6</u>		-	-	1.6	V
Dynamic	characteristics						
t _{rr}	reverse recovery time	$I_F = 1 \text{ A}; V_R = 30 \text{ V}; dI_F/dt = 50 \text{ A}/\mu\text{s};$ $T_j = 25 \text{ °C}; Fig. 7$		-	35	50	ns
		I_F = 10 A; V_R = 200 V; dI_F/dt = 200 A/µs; T_j = 25 °C; Fig. 7		-	50	-	ns
		I_F = 10 A; V _R = 200 V; dI _F /dt = 200 A/µs; T _j = 125 °C; <u>Fig. 7</u>		-	78	-	ns
		$I_F = 10 \text{ A}; V_R = 400 \text{ V}; dI_F/dt = 500 \text{ A}/\mu\text{s};$ $T_i = 25 \text{ °C}; Fig. 7$		-	42	-	ns

Table 1. Quick reference data

5. Pinning information

Table 2. F	Pinning infor	mation		
Pin	Symbol	Description	Simplified outline	Graphic symbol
1	К	cathode	mb	K — — A 001aaa020
2	А	anode		001888020
mb	n.c.	mounting base; isolated		

6. Ordering information

Table 3. Ordering information						
Type number	Package	kage				
	Name	Description	Version			
BYV10EX-600P	TO-220F	plastic single-ended package; isolated heatsink mounted; 1 mounting hole; 2-lead TO-220 "full pack"	SOD113			

7. Marking

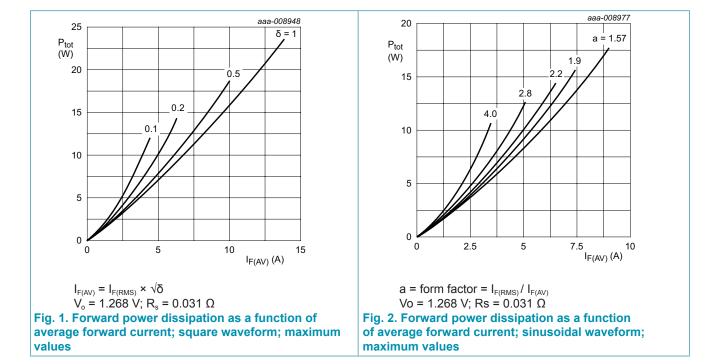
Table 4. Marking codes	
Type number	Marking codes
BYV10EX-600P	BYV10EX-600P

8. Limiting values

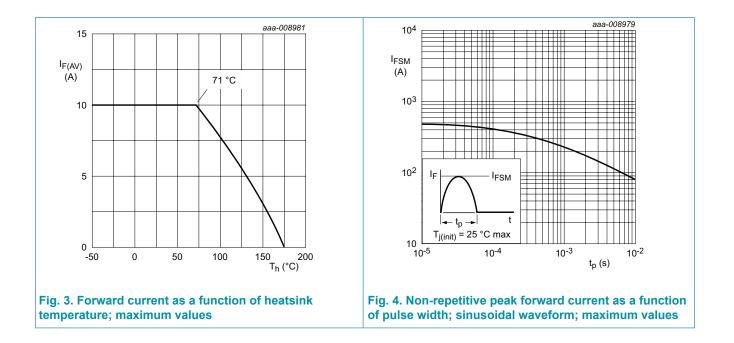
Table 5. Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134).

Symbol	Parameter	Conditions	Values	Unit
V_{RRM}	repetitive peak reverse voltage		600	V
V _{RWM}	crest working reverse voltage		600	V
V _R	reverse voltage	DC	600	V
I _{F(AV)}	average forward current	δ = 0.5 ; square-wave pulse; T _h ≤ 71 °C; Fig. 1; Fig. 2; Fig. 3	10	A
I _{FRM}	repetitive peak forward current	δ = 0.5; t _p = 25 μs; T _h ≤ 71 °C; square-wave pulse	20	A
I _{FSM}	non-repetitive peak forward current	t_p = 10 ms; $T_{j(init)}$ = 25 °C; sine-wave pulse; Fig. 4	75	A
		t_p = 8.3 ms; $T_{j(init)}$ = 25 °C; sine-wave pulse;	83	А
T _{stg}	storage temperature		-65 to 175	°C
T _j	junction temperature		175	°C

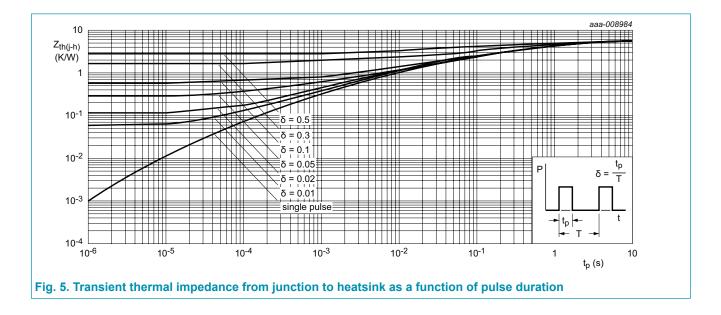


BYV10EX-600P Ultrafast power diode



9. Thermal characteristics

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
R _{th(j-h)}	thermal resistance from junction to	With heatsink compound; Fig. 5	-	-	5.5	K/W
	heatsink	Without heatsink compound	-	-	7.2	K/W
$R_{\text{th(j-a)}}$	thermal resistance from junction to ambient free air	in free air	-	55	-	K/W



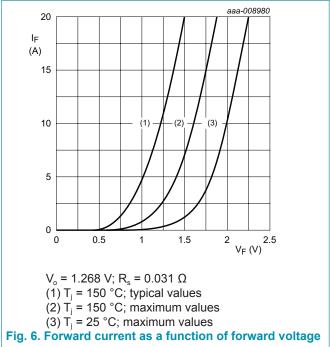
10. Isolation characteristics

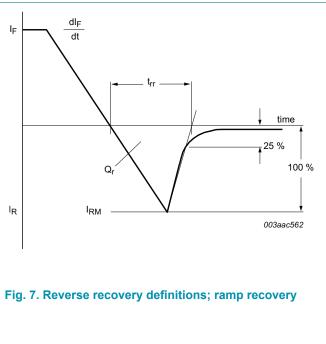
Table 6. Isolation characteristics

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
V _{isol(RMS)}	RMS isolation voltage	50 Hz \leq f \leq 60 Hz; RH \leq 65 %; from all pins to external heatsink; sinusoidal waveform; clean and dust free	-	-	2500	V
C _{isol}	isolation capacitance	from cathode to external heatsink	-	10	-	PF

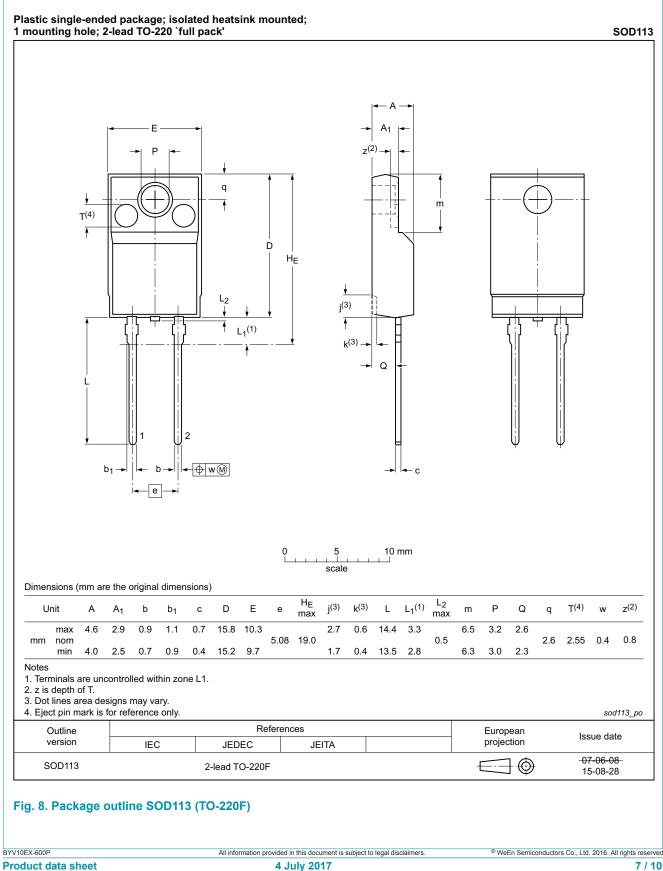
11. Characteristics

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
Static cha	racteristics	· ·				
V _F	forward current	I _F = 10 A; T _j = 25 °C; <u>Fig. 6</u>	-	1.55	2	V
		I _F = 10 A; T _j = 150 °C; <u>Fig. 6</u>	-	-	1.6	V
I _R	reverse current	V _R = 600 V; T _j = 25 °C	-	-	10	μA
		V _R = 600 V; T _j = 150 °C	-	-	250	μA
Dynamic (characteristics	· ·				
Q _r reverse charge	reverse charge	$I_{F} = 10 \text{ A}; V_{R} = 200 \text{ V}; dI_{F}/dt = 200 \text{ A}/\mu\text{s}; T_{j} = 25 \text{ °C}; Fig. 7$	-	123	-	nC
		$I_{F} = 10 \text{ A}; V_{R} = 200 \text{ V}; dI_{F}/dt = 200 \text{ A}/\mu\text{s}; T_{j} = 125 \text{ °C}; Fig. 7$	-	305	-	nC
t _{rr}	reverse recovery time	$I_F = 1 \text{ A}; V_R = 30 \text{ V}; dI_F/dt = 50 \text{ A}/\mu\text{s};$ $T_j = 25 \text{ °C}; Fig. 7$	-	35	50	ns
		I_F = 10 A; V_R = 200 V; dI_F/dt = 200 A/µs; T_j = 25 °C; Fig. 7	-	50	-	ns
		$I_{F} = 10 \text{ A}; V_{R} = 200 \text{ V}; dI_{F}/dt = 200 \text{ A}/\mu\text{s}; T_{j} = 125 ^{\circ}\text{C}; Fig. 7$	-	78	-	ns
		$I_F = 10 \text{ A}; V_R = 400 \text{ V}; dI_F/dt = 500 \text{ A}/\mu\text{s};$ $T_j = 25 \text{ °C}; Fig. 7$	-	42	-	ns
I _{RM}	peak reverse recovery current	$I_F = 10 \text{ A}; V_R = 200 \text{ V}; dI_F/dt = 200 \text{ A}/\mu\text{s};$ $T_j = 25 \text{ °C}; Fig. 7$	-	4.9	-	A
		$I_{F} = 10 \text{ A}; V_{R} = 200 \text{ V}; dI_{F}/dt = 200 \text{ A}/\mu\text{s}; T_{j} = 125 \text{ °C}; Fig. 7$	-	7.8	-	A
E _{as}	non-repetitive avalanche energy	I _R = 1.2 A; T _{j(init)} = 25 °C; L = 15 mH	10.8	-	-	mJ





12. Package outline



BYV10EX-600P

13. Legal information

Data sheet status

Document status [1][2]	Product status [3]	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
Preliminary [short] data sheet	Qualification	This document contains data from the preliminary specification.
Product [short] data sheet	Production	This document contains the product specification.

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